

1200V SiC N-Channel MOSFET

MAIN CHARACTERISTICS

I_D	110A
V_{DS}	1200V
$R_{DS(on)-typ}$ (@ $V_{GS}=18V$ $T_C=25^{\circ}C$)	$<22m\Omega$ (Typ:16m Ω)

FEATURES

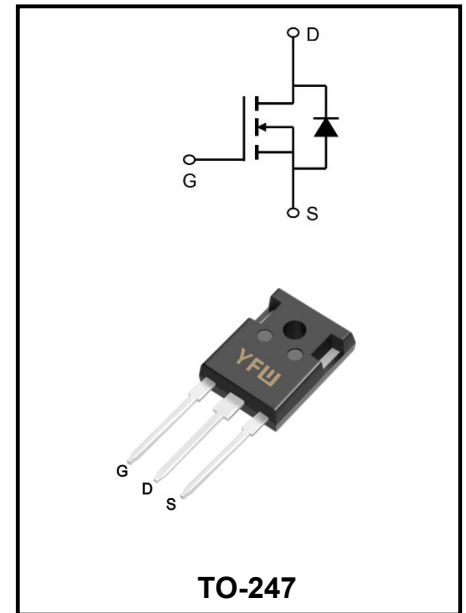
- ♦ High Speed Switching with Low Capacitances
- ♦ High Blocking Voltage with Low RDS(on)
- ♦ Easy to Parallel
- ♦ Simple to Drive
- ♦ RoHS Compliant

BENEFITS

- ♦ Increased Power Density
- ♦ Faster Operating Frequency
- ♦ Reduction of Heat Sink Requirements
- ♦ Higher Efficiency
- ♦ Reduced EMI

APPLICATIONS

- ♦ Power Factor Correction Modules
- ♦ Switch Mode Power Supplies
- ♦ DC-AC Inverters
- ♦ High Voltage DC/DC Converters



Maximum Ratings at $T_C=25^{\circ}C$ unless otherwise specified

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	1200	V
Max Gate-Source Voltage	V_{GS}	-10/+22	V
Recommended Operation Value	V_{GSop}	-4/+18	V
Continue Drain Current $T_C=25^{\circ}C$	I_D	111	A
Continue Drain Current $T_C=100^{\circ}C$		78	A
Pulsed Drain Current (Note1)	I_{DM}	230	A
Power Dissipation $T_C=25^{\circ}C$	P_D	468	W
Power Dissipation $T_C=100^{\circ}C$	P_D	202	W
Operating Temperature Range	T_J	-55 to +175	$^{\circ}C$
Storage Temperature Range	T_{STG}	-55 to +175	$^{\circ}C$
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.32	$^{\circ}C/W$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	26.8	$^{\circ}C/W$

Note1:Pulse test: 300 μs pulse width, 2 % duty cycle

Electrical Characteristics at Tc=25°C unless otherwise specified

Parameter	Test Condition	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 1\text{ mA}$	BV_{DSS}	1200	-	-	V
Drain-Source Leakage Current	$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$	I_{DSS}	-	1	10	μA
Gate Leakage Current	$V_{GS} = 22\text{ V}, V_{DS} = 0\text{ V}$	I_{GSS}	-	-	100	nA
Gate Leakage Current	$V_{GS} = -10\text{ V}, V_{DS} = 0\text{ V}$	I_{GSS}	-	-	-100	nA
Gate-Source Threshold Voltage T _c = 25°C	$V_{DS} = V_{GS}, I_D = 20\text{ mA}$	$V_{GS(th)}$	2.2	3.2	4.2	V
Gate-Source Threshold Voltage T _c = 175°C	$V_{DS} = V_{GS}, I_D = 20\text{ mA}$ $T_J = 175^\circ\text{C}$		-	2.3	-	V
Drain-Source On-State Resistance	$V_{GS} = 18\text{ V}, I_D = 60\text{ A}$	$R_{DS(on)}$	-	16	22	mΩ
	$V_{GS} = 18\text{ V}, I_D = 60\text{ A}, T_J = 175^\circ\text{C}$		-	28	-	
Internal Gate Resistance	$f = 1\text{ MHz}$	$RG(int)$	-	1.4	-	Ω
Input Capacitance	$V_{GS} = 0\text{ V}$	C_{iss}	-	5073	-	pF
Output Capacitance	$V_{DS} = 1000\text{ V}$	C_{oss}	-	217	-	
Reverse Transfer Capacitance	$f = 1\text{ MHz}$	C_{rss}	-	18	-	
Total Gate Charge(Note2)	$I_D = 60\text{ A}$ $V_{DD} = 800\text{ V}$ $V_{GS} = -5/18\text{ V}$	Q_G		213		nC
Gate to Source Charge(Note2)		Q_{GS}		63		
Gate to Drain Charge(Note2)		Q_{GD}		27		
Turn-on Delay Time(Note2)	$V_{DS} = 800\text{ V},$ $I_D = 60\text{ A},$ $V_{GS} = -5/18\text{ V},$ $R_G = 5.1\Omega,$	$t_{d(ON)}$	-	24	-	ns
Rise Time(Note2)		t_r	-	27	-	
Turn-Off Delay Time(Note2)		$t_{d(OFF)}$	-	57	-	
Fall Time(Note2)		t_f	-	17	-	
Turn-On Energy		E_{on}	-	661	-	μJ
Turn-Off Energy		E_{off}	-	590	-	μJ
Maximun Body-Diode Continuous Current	T _c =25°C	I_S	-	111	-	A
Maximun Body-Diode Continuous Current	T _c =100°C		-	62	-	A
Maximun Body-Diode Pulsed Current(Note2)		I_{SM}	-	220	-	A
Drain-Source Diode Forward Voltage	$V_{GS} = -5\text{ V}, I_{SD} = 30\text{ A}, T_J = 25^\circ\text{C}$	V_{SD}	-	3.7	-	V
Drain-Source Diode Forward Voltage	$V_{GS} = -5\text{ V}, I_{SD} = 30\text{ A}, T_J = 175^\circ\text{C}$		-	3.4	-	V
Reverse Recovery Time(Note2)	$V_{GS} = -5\text{ V}, I_{SD} = 60\text{ A},$ $V_R = 800\text{ V}, diF/dt = 1000\text{ A}/\mu\text{s}$	trr	-	20	-	ns
Reverse Recovery Charge(Note2)		Q_{rr}	-	149	-	nC
Peak Reverse Recovery Current		I_{rrm}	-	12.5	-	A

Note2:Pulse test: 300 μs pulse width, 2 % duty cycle

RATINGS AND CHARACTERISTIC CURVES

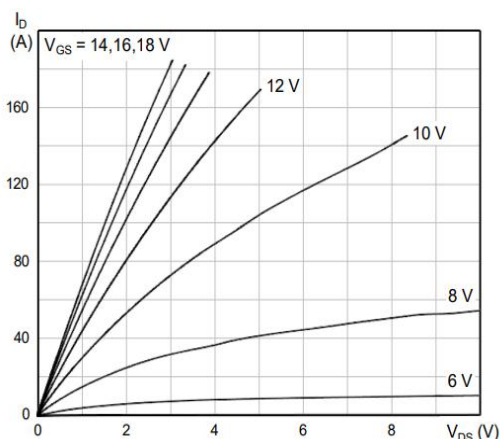


Figure 1 Typical Forward Output Characteristics at $T_J = 25^\circ\text{C}$

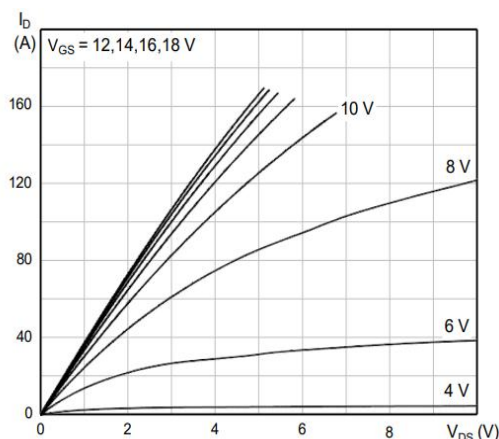


Figure 2 Typical Forward Output Characteristics at $T_J = 175^\circ\text{C}$

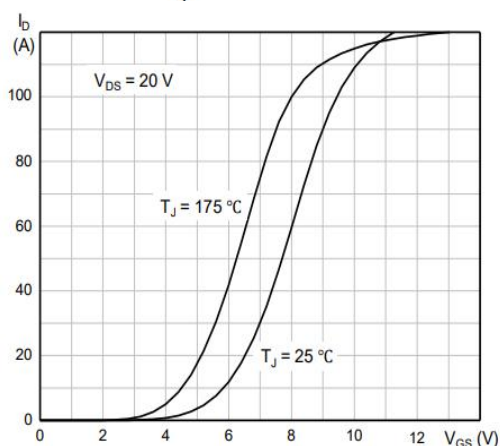


Figure 3 Typical Transfer Characteristic

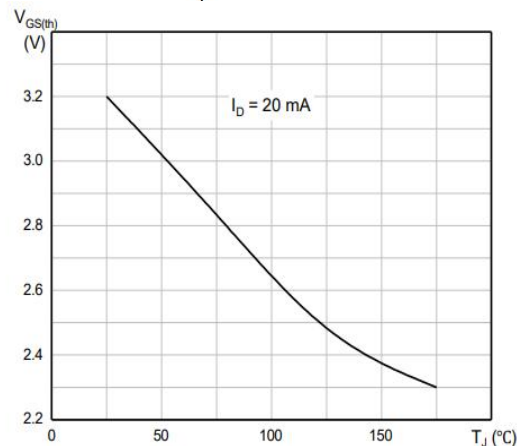


Figure 4 Threshold Voltage vs. Temperature

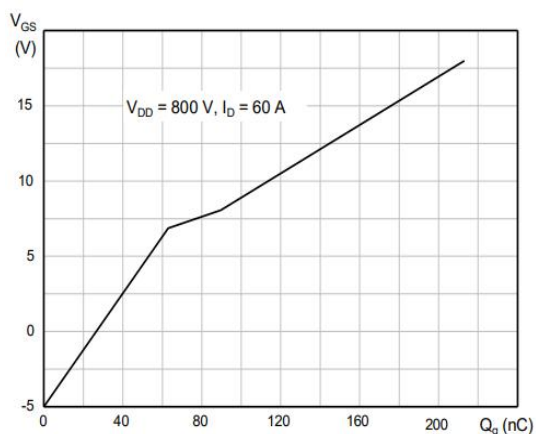


Figure 5 Gate Charge Characteristics

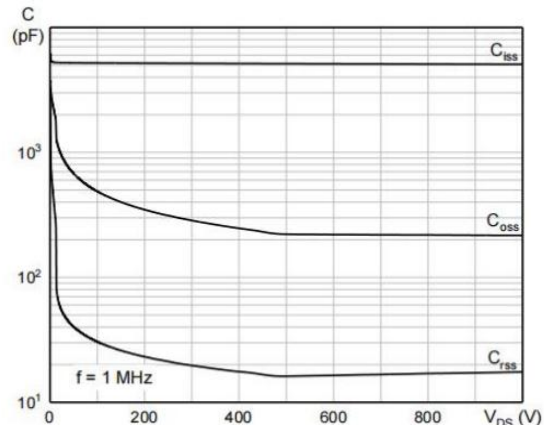


Figure 6 Capacitance vs. Drain-Source Voltage (0 - 1000V)

RATINGS AND CHARACTERISTIC CURVES

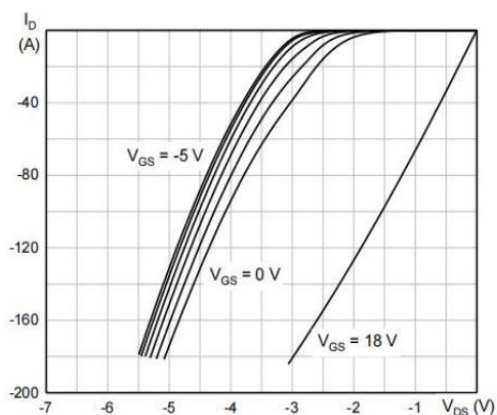


Figure 7 Body Diode Characteristics at $T_j=25^\circ\text{C}$

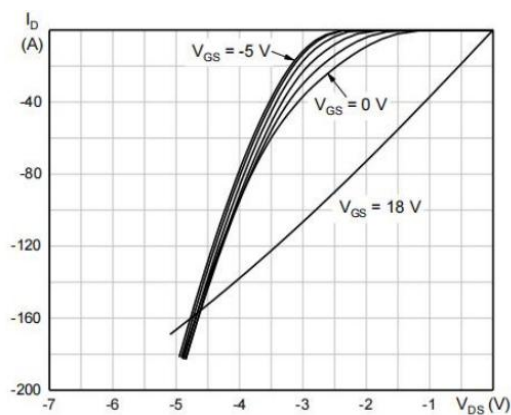


Figure 8 Body Diode Characteristics at $T_j=175^\circ\text{C}$

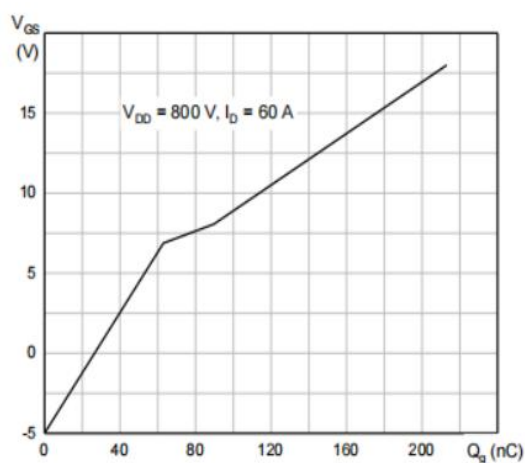


Figure 9 Gate Charge Characteristics

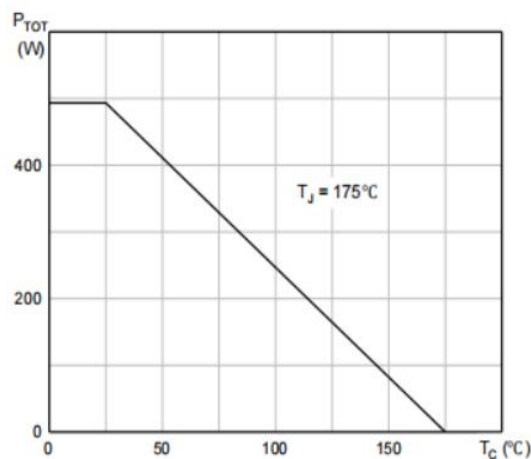


Figure 10 Maximum Power Dissipation Derating vs. Case Temperature

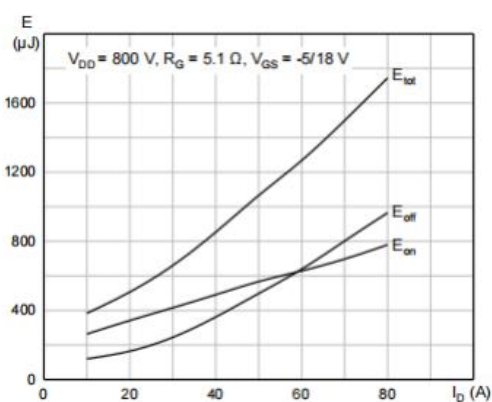


Figure 11 Clamped Inductive Switching Energy vs. Drain Current

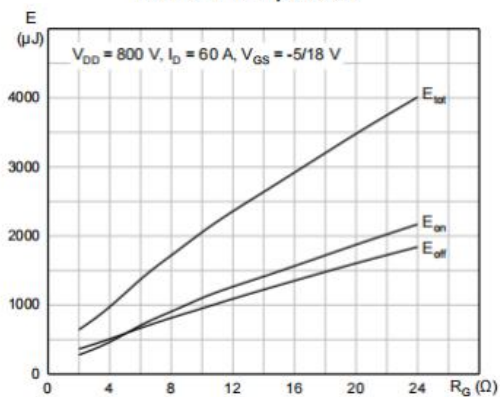


Figure 12 Clamped Inductive Switching Energy vs. External Gate Resistance

RATINGS AND CHARACTERISTIC CURVES

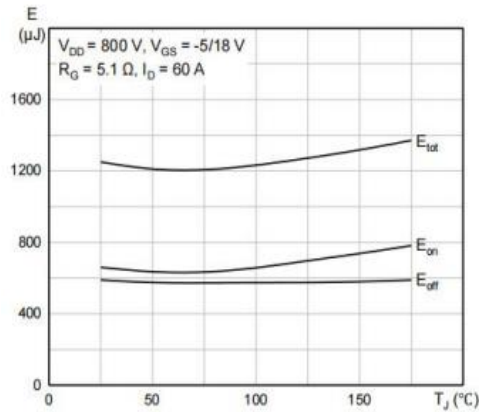


Figure 13 Clamped Inductive Switching Energy vs. Temperature

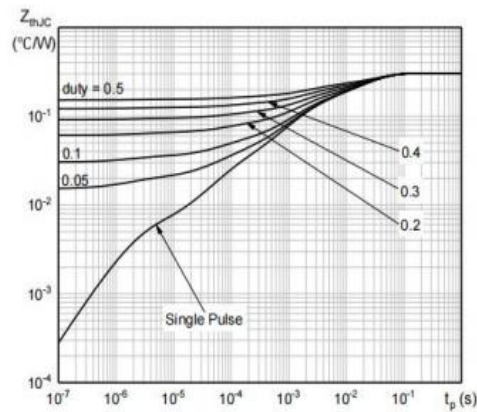


Figure 14 Transient Thermal Impedance (Junction - Case)

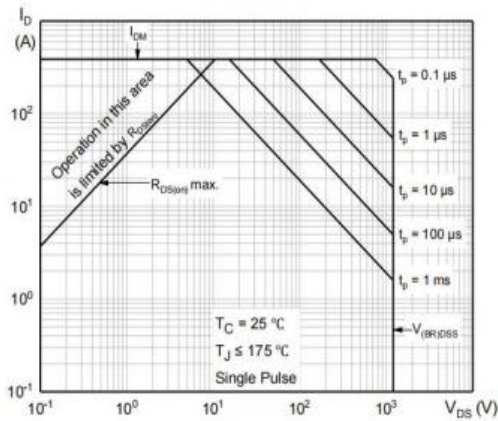


Figure 15 Forward Biased Safe Operating Area

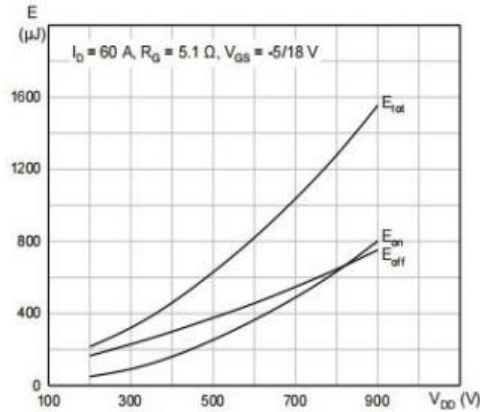


Figure 16 Typical Switching Energy vs. Supply Voltage

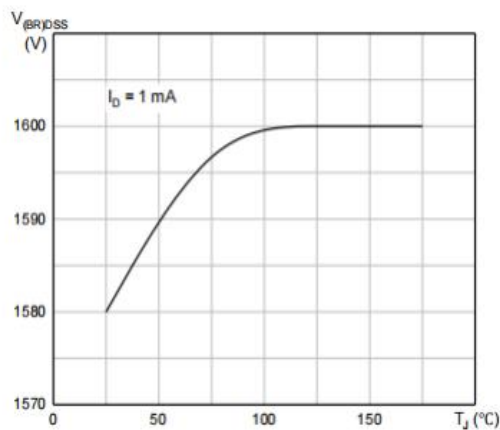
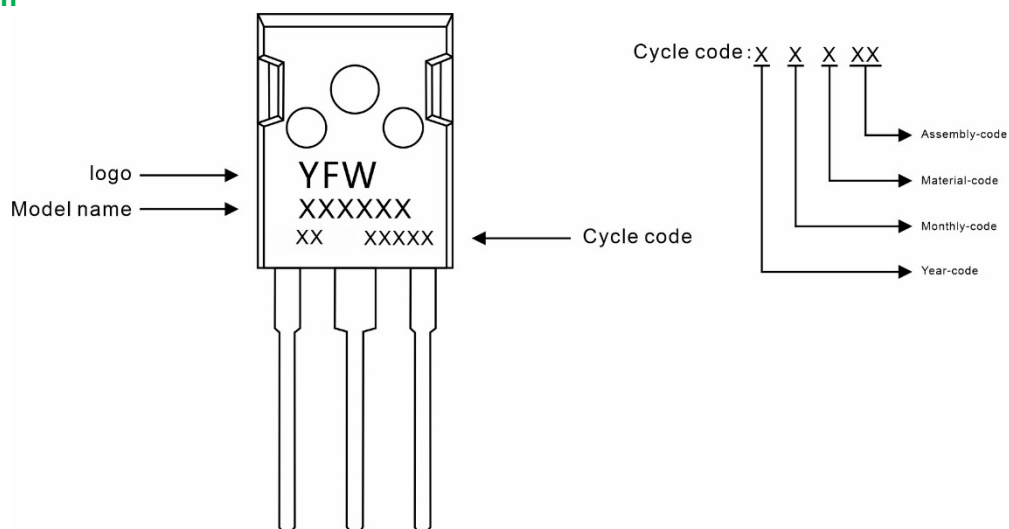


Figure 17 Breakdown Voltage vs. Temperature

Marking Diagram



Ordering information

Model name	Package	Unit Weight	Base Quantity	Packing Quantity
YFWM3016120APG3	TO-247	0.209oz(5.93g)	30pcs/tube	600PCS/Box 2400PCS/Carton

Package Dimensions

TO-247

Symbol	Dimensions in mm		Dimensions in Inch	
	Min.	Max.	Min.	Max.
A	4.90	5.10	0.193	0.201
A1	1.90	2.10	0.075	0.083
A2	2.29	2.54	0.090	0.100
b	1.00	1.40	0.039	0.055
b1	2.00	2.20	0.079	0.087
b2	3.00	3.20	0.118	0.126
c	0.50	0.70	0.020	0.028
D	15.75	16.05	0.620	0.632
E	20.20	20.80	0.795	0.819
e	5.45 (BSC)		0.215 (BSC)	
e1	10.90 (BSC)		0.429 (BSC)	
F	6.05	6.25	0.238	0.246
F1	5.80	6.00	0.228	0.236
L	20.10	20.40	0.791	0.803
L1	4.05	4.35	0.159	0.171
Φ	3.50	3.70	0.138	0.146

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